

HSF

NOTES:

Current Rating: 3.0AMP

Contact Resistance:30mΩ max

Withstand Voltage:1000V AC/DC

Insulation Resistance:1000MΩ

Operation Temperature:-55℃~+105℃

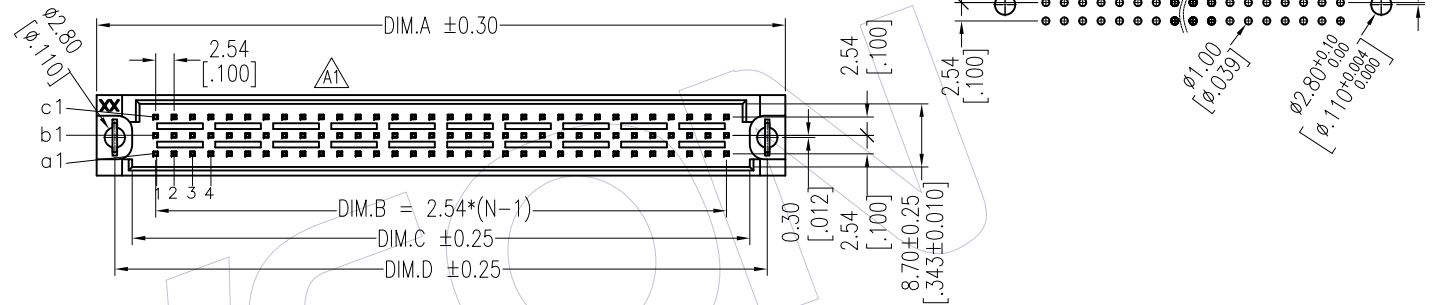
Contact Material: Brass

Contact Plating: Au and Sn over Ni

Fixing Material: Phosphor Bronze

Fixing Plating: Sn over Ni

Insulation Material: PBT+30% G.F(UL94V-0)

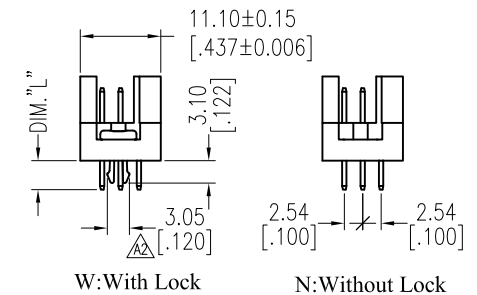
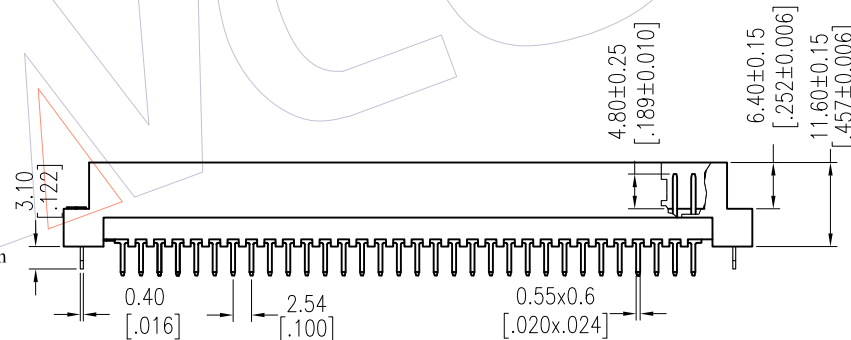
Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

Ordering Information

3410-3 XX X MS SX

X A X

No. of Pins	Rows with contacts	Contact Plating:	Packing:	DIP length
Per Row	A=a+b+c	S0=Gold Flash/Tin	A=Tray	1:L=2.50
10pin	B=a+b	S1=3u"Gold/Tin		2:L=3.00
16pin	C=a+c	S3=10u"Gold/Tin		3:L=4.00
32pin	D=a	S4=15u"Gold/Tin	W=With Lock	4:L=4.57
		S5=30u"Gold/Tin	N=Without Lock	
		SN=Tin		



W: With Lock

N: Without Lock

R	96	3	32	95.00	78.74	85.20	90.00
R/2	48	3	16	54.40	38.10	44.60	50.00
R/3	30	3	10	39.16	22.86	29.30	34.76
TYPE	POS.	ROWS	N	DIM.A	DIM.B	DIM.C	DIM.D

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION	DRAW	DATE	SCALE	FIT	PART NO.
A2	2014/08/12	Modify the dim	—	X.X	JYHuang	2014/08/12	UNIT	mm inch	3410-3XXXMSSXXAX
A1	2014/06/26	Modify	—	X.XX	CHECK	DATE	SIZE	A4	TITLE:
AO	2014/06/05	NEW	—	X.XXX	APPROVE	DATE	SHEET	1/1	2.54PITCH DIN 41612 Male 180° DIP (R-Type)
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	Angle DIM	± 3° TOL	DATE	PROJ.	Customer NO.	